

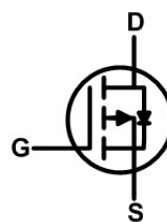
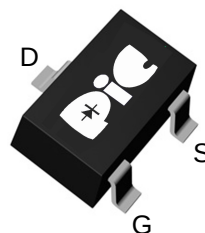
## ➤ General Description

This PAP3111N P-Channel enhancement mode power field effect transistor is the high density trench technology and this advanced technology can provide excellent  $R_{ds(On)}$  performance and efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

## ➤ Feature

- Super Low Gate Charge
- Green Device Available
- Excellent  $CdV/dt$  effect decline
- Advanced high cell density Trench technology
- SOT-23 Package design

## ➤ SOT-23



## ➤ Application

- Load Switch
- Portable instrument
- MB / NB / 3C device

## ➤ Absolute Maximum Ratings

| Parameter                                                  | Symbol                 | Rating     |             | Units        |
|------------------------------------------------------------|------------------------|------------|-------------|--------------|
|                                                            |                        | 10s        | SteadyState |              |
| Drain-Source Voltage                                       | $V_{DS}$               | -30        |             | V            |
| Gate-Source Voltage                                        | $V_{GS}$               | $\pm 20$   |             | V            |
| Continuous Drain Current, $V_{GS}$ @ -10V <sup>1</sup>     | $I_D @ T_A=25^\circ C$ | -3.8       | -3.3        | A            |
| Continuous Drain Current, $V_{GS}$ @ -10V <sup>1</sup>     | $I_D @ T_A=70^\circ C$ | -3.1       | -2.7        | A            |
| Pulsed Drain Current <sup>2</sup>                          | $I_{DM}$               | -17        |             | A            |
| Total Power Dissipation <sup>3</sup>                       | $P_D @ T_A=25^\circ C$ | 1.32       | 1           | W            |
| Total Power Dissipation <sup>3</sup>                       | $P_D @ T_A=70^\circ C$ | 0.84       | 0.64        | W            |
| Storage Temperature Range                                  | $T_{STG}$              | -55 to 150 |             | $^\circ C$   |
| Operating Junction Temperature Range                       | $T_J$                  | -55 to 150 |             | $^\circ C$   |
| Thermal Resistance Junction-Ambient <sup>1</sup>           | $R_{\theta JA}$        | 125        |             | $^\circ C/W$ |
| Thermal Resistance Junction-Ambient <sup>1</sup> (t ≤ 10s) | $R_{\theta JA}$        | 95         |             | $^\circ C/W$ |
| Thermal Resistance Junction-Case <sup>1</sup>              | $R_{\theta JC}$        | 80         |             | $^\circ C/W$ |

### ➤ Electrical Characteristics ( $T_J=25^\circ C$ Unless otherwise noted)

| Parameter                                      | Symbol                       | Conditions                                                     | Min. | Typ.   | Max.      | Unit           |
|------------------------------------------------|------------------------------|----------------------------------------------------------------|------|--------|-----------|----------------|
| Drain-Source Breakdown Voltage                 | $BV_{DSS}$                   | $V_{GS}=0V$ , $I_D=-250\mu A$                                  | -30  | ---    | ---       | V              |
| $BV_{DSS}$ Temperature Coefficient             | $\Delta BV_{DSS}/\Delta T_J$ | Reference to $25^\circ C$ , $I_D=-1mA$                         | ---  | -0.023 | ---       | V/ $^\circ C$  |
| Static Drain-Source On-Resistance <sup>2</sup> | $R_{DS(ON)}$                 | $V_{GS}=-10V$ , $I_D=-3A$                                      | ---  | 42     | 52        | $m\Omega$      |
|                                                |                              | $V_{GS}=-4.5V$ , $I_D=-2A$                                     | ---  | 75     | 90        |                |
| Gate Threshold Voltage                         | $V_{GS(th)}$                 | $V_{GS}=V_{DS}$ , $I_D=-250\mu A$                              | -1.2 | -1.6   | -2.5      | V              |
| $V_{GS(th)}$ Temperature Coefficient           | $\Delta V_{GS(th)}$          |                                                                | ---  | 4      | ---       | mV/ $^\circ C$ |
| Drain-Source Leakage Current                   | $I_{DSS}$                    | $V_{DS}=-24V$ , $V_{GS}=0V$ , $T_J=25^\circ C$                 | ---  | ---    | -1        | $\mu A$        |
|                                                |                              | $V_{DS}=-24V$ , $V_{GS}=0V$ , $T_J=55^\circ C$                 | ---  | ---    | -5        |                |
| Gate-Source Leakage Current                    | $I_{GSS}$                    | $V_{GS}=\pm 20V$ , $V_{DS}=0V$                                 | ---  | ---    | $\pm 100$ | nA             |
| Forward Transconductance                       | $g_{fs}$                     | $V_{DS}=-5V$ , $I_D=-3A$                                       | ---  | 11     | ---       | S              |
| Total Gate Charge (-4.5V)                      | $Q_g$                        | $V_{DS}=-15V$ , $V_{GS}=-4.5V$ , $I_D=-3A$                     | ---  | 6.4    | 9.0       | nC             |
| Gate-Source Charge                             | $Q_{gs}$                     |                                                                | ---  | 2.3    | 3.2       |                |
| Gate-Drain Charge                              | $Q_{gd}$                     |                                                                | ---  | 1.9    | 2.7       |                |
| Turn-On Delay Time                             | $T_{d(on)}$                  | $V_{DD}=-15V$ , $V_{GS}=-10V$ ,<br>$R_G=3.3\Omega$ , $I_D=-3A$ | ---  | 2.8    | 5.6       | ns             |
| Rise Time                                      | $T_r$                        |                                                                | ---  | 8.4    | 15.1      |                |
| Turn-Off Delay Time                            | $T_{d(off)}$                 |                                                                | ---  | 39     | 78.0      |                |
| Fall Time                                      | $T_f$                        |                                                                | ---  | 6      | 12.0      |                |
| Input Capacitance                              | $C_{iss}$                    | $V_{DS}=-15V$ , $V_{GS}=0V$ , $f=1MHz$                         | ---  | 583    | 816       | pF             |
| Output Capacitance                             | $C_{oss}$                    |                                                                | ---  | 100    | 140       |                |
| Reverse Transfer Capacitance                   | $C_{rss}$                    |                                                                | ---  | 80     | 112       |                |

### ➤ Diode Characteristics

| Parameter                                | Symbol   | Conditions                                           | Min. | Typ. | Max. | Unit |
|------------------------------------------|----------|------------------------------------------------------|------|------|------|------|
| Continuous Source Current <sup>1,4</sup> | $I_S$    | $V_G=V_D=0V$ , Force Current                         | ---  | ---  | -3.3 | A    |
| Pulsed Source Current <sup>2,4</sup>     | $I_{SM}$ |                                                      | ---  | ---  | -17  | A    |
| Diode Forward Voltage <sup>2</sup>       | $V_{SD}$ | $V_{GS}=0V$ , $I_S=-1A$ , $T_J=25^\circ C$           | ---  | ---  | -1   | V    |
| Reverse Recovery Time                    | $t_{rr}$ | $I_F=-3A$ , $dI/dt=100A/\mu s$ ,<br>$T_J=25^\circ C$ | ---  | 7.8  | ---  | nS   |
| Reverse Recovery Charge                  | $Q_{rr}$ |                                                      | ---  | 2.5  | ---  | nC   |

Note :

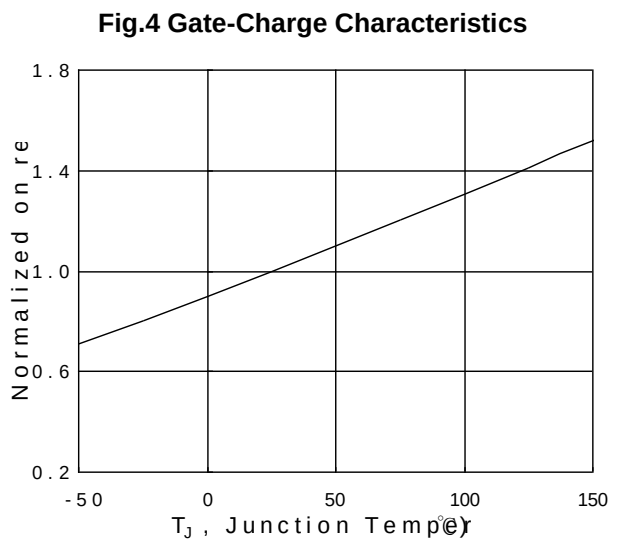
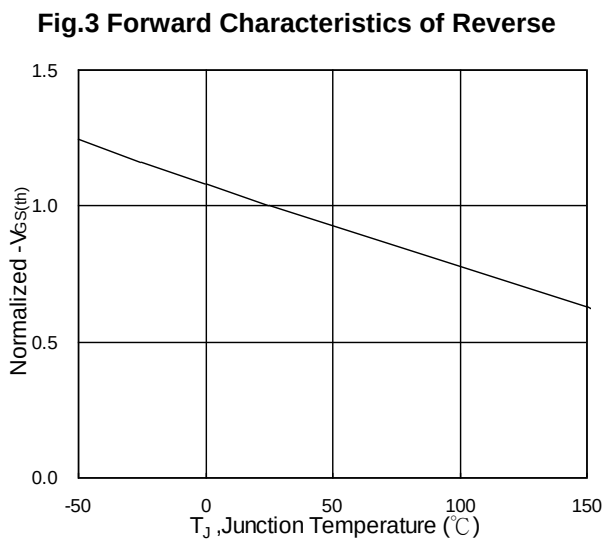
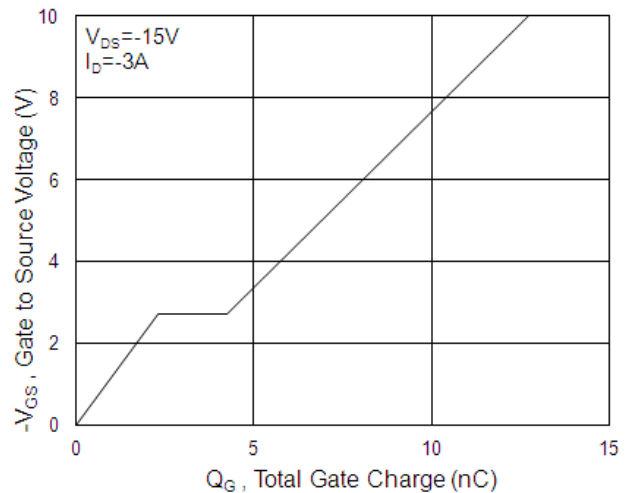
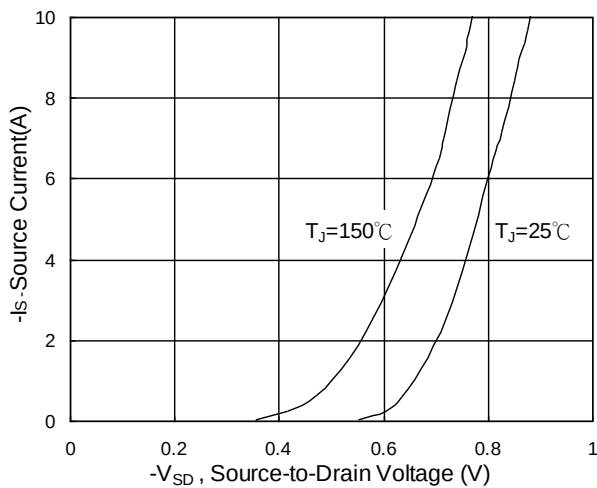
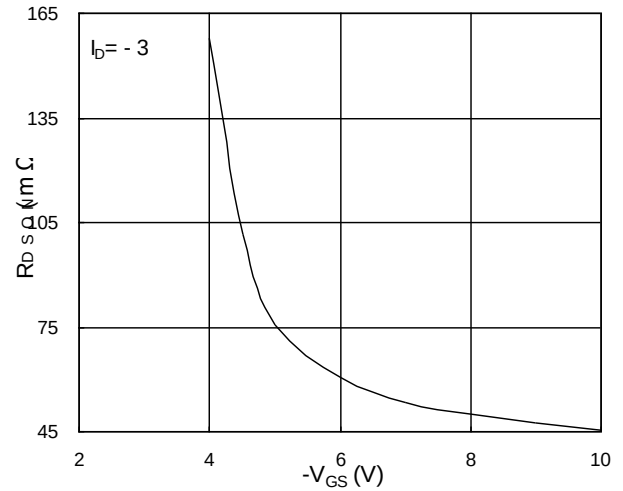
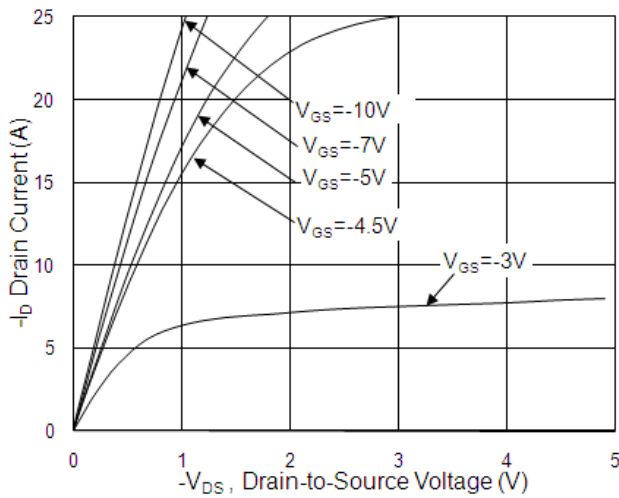
1.Pulse width limited by maximum junction temperature.

2.The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$

3.Ensure that the channel temperature does not exceed  $150^\circ C$ .

4.The data is theoretically the same as  $I_D$  and  $I_{DM}$  , in real applications , should be limited by total power dissipation.

### ➤ Typical Characteristics



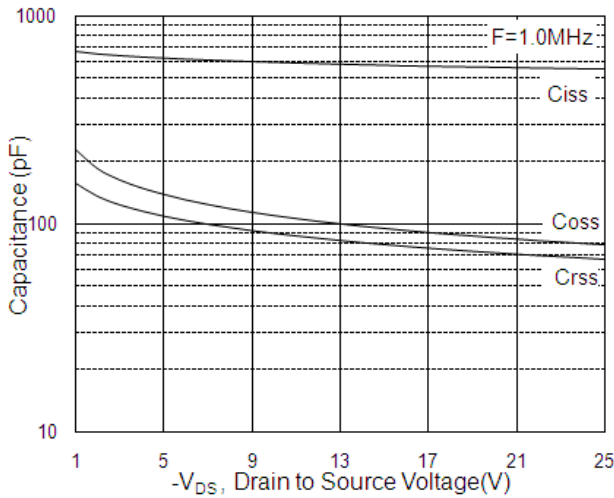


Fig.7 Capacitance

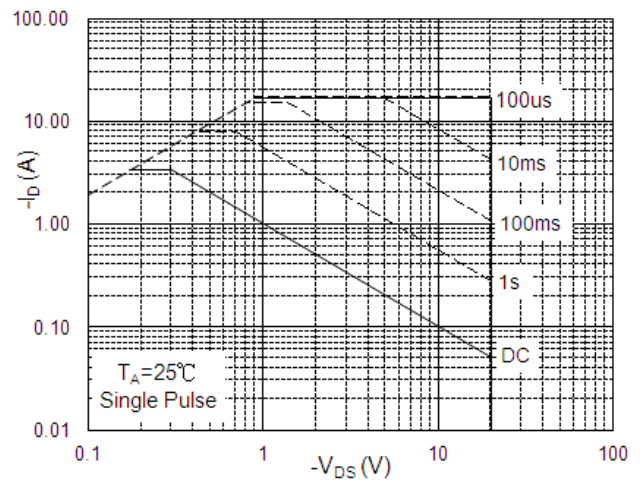


Fig.8 Safe Operating Area

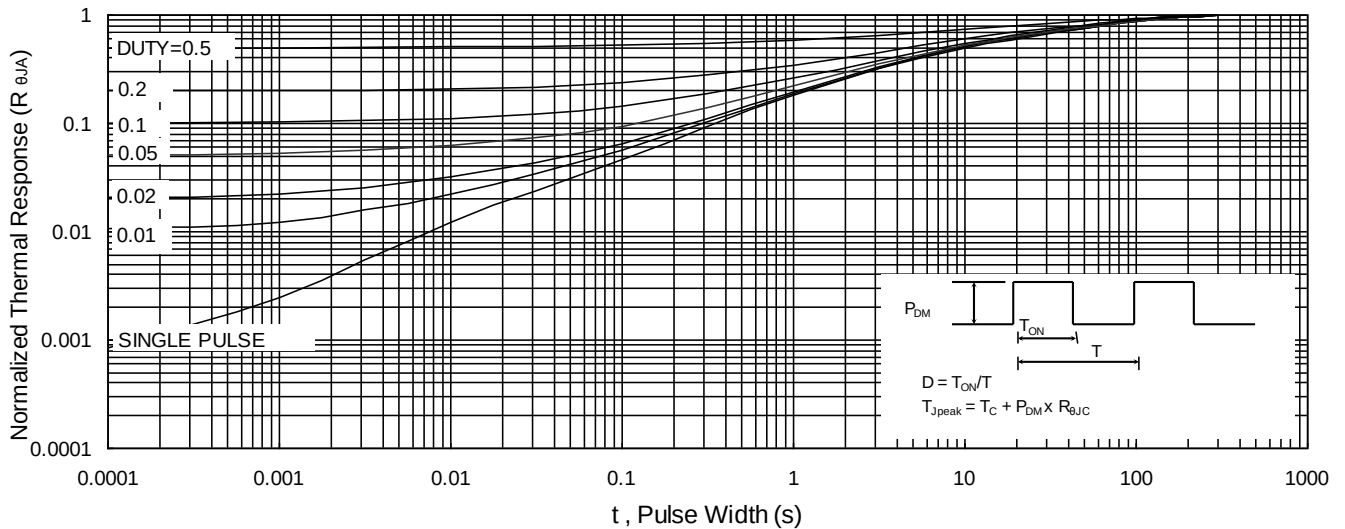


Fig.9 Normalized Maximum Transient Thermal Impedance

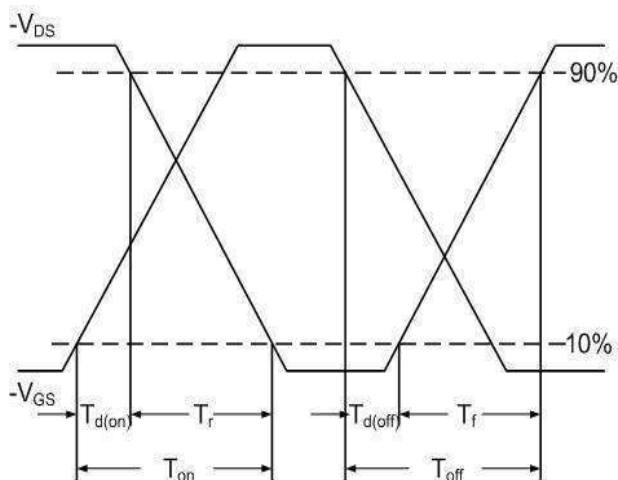


Fig.10 Switching Time Waveform

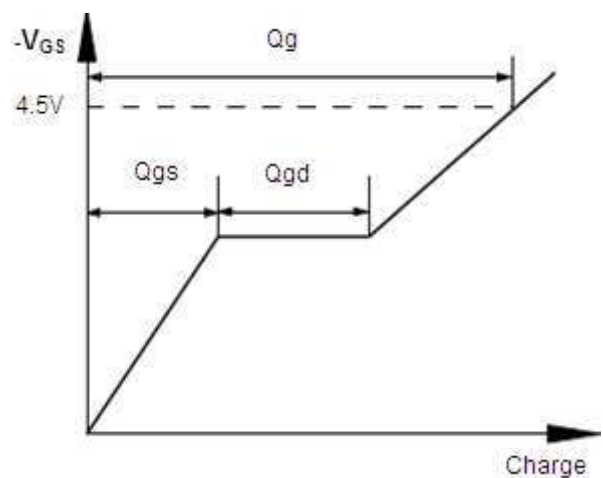
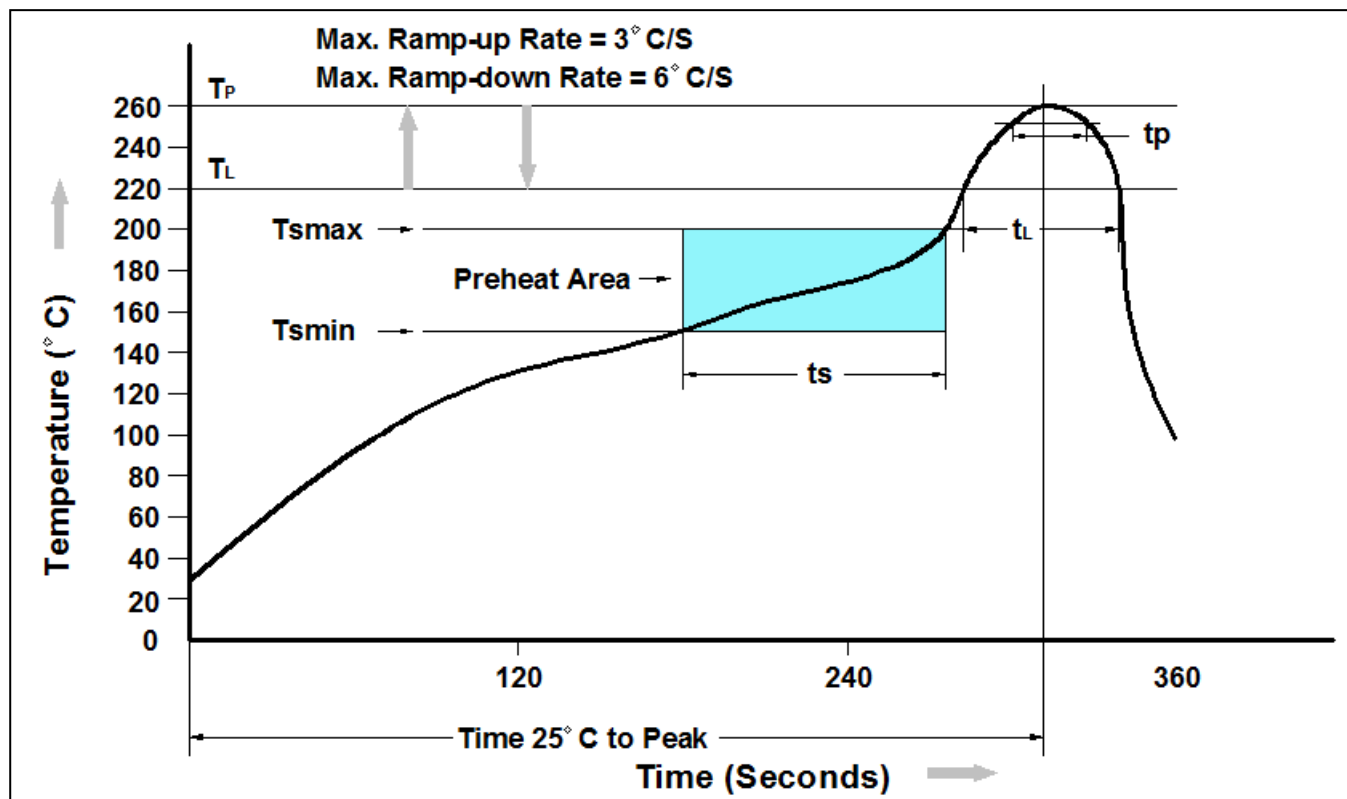


Fig.11 Gate Charge Waveform

## ➤ Recommend IR Reflow Soldering Thermal Profile

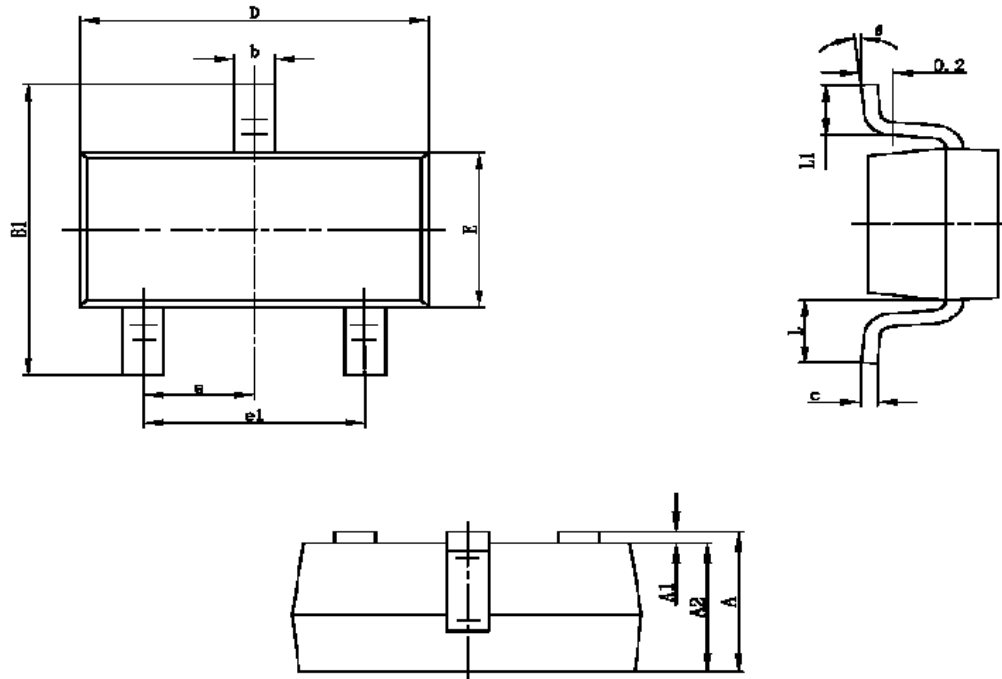


| Profile Feature                                      | Pb-Free Assembly Profile |
|------------------------------------------------------|--------------------------|
| Temperature Min. ( $T_{smin}$ )                      | 150°C                    |
| Temperature Max. ( $T_{smax}$ )                      | 200°C                    |
| Time ( $t_s$ ) from ( $T_{smin}$ to $T_{smax}$ )     | 60-120 seconds           |
| Average Ramp-up Rate ( $t_L$ to $t_P$ )              | 3°C/second max.          |
| Liquidous Temperature ( $T_L$ )                      | 217°C                    |
| Time ( $t_L$ ) Maintained Above ( $T_L$ )            | 60 – 150 seconds         |
| Peak Temperature                                     | 260°C +0°C / -5°C        |
| Time ( $t_P$ ) within 5°C of actual Peak Temperature | 30 seconds               |
| Ramp-down Rate ( $T_P$ to $T_L$ )                    | 6°C/second max           |
| Time 25°C to Peak Temperature                        | 8 minutes max.           |

## ➤ Ordering Information

| Part Number | Description | Quantity |
|-------------|-------------|----------|
| PAP3111N    | SOT-23 Reel | 3000 pcs |

## ➤ Package Information ( SOT- 23 )



| Symbol   | Dimensions In Millimeters |       | Dimensions In Inches |       |
|----------|---------------------------|-------|----------------------|-------|
|          | Min                       | Max   | Min                  | Max   |
| A        | 1.050                     | 1.250 | 0.041                | 0.049 |
| A1       | 0.000                     | 0.100 | 0.000                | 0.004 |
| A2       | 1.050                     | 1.150 | 0.041                | 0.045 |
| b        | 0.300                     | 0.400 | 0.012                | 0.016 |
| c        | 0.100                     | 0.200 | 0.004                | 0.008 |
| D        | 2.820                     | 3.020 | 0.111                | 0.119 |
| E        | 1.500                     | 1.700 | 0.059                | 0.067 |
| E1       | 2.650                     | 2.950 | 0.104                | 0.116 |
| e        | 0.950TYP                  |       | 0.037TYP             |       |
| e1       | 1.800                     | 2.000 | 0.071                | 0.079 |
| L        | 0.700REF                  |       | 0.028REF             |       |
| L1       | 0.300                     | 0.600 | 0.012                | 0.024 |
| $\theta$ | 0°                        | 8°    | 0°                   | 8°    |

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